

1998 Fairchild Semiconductor Corporation

Electrical Characteristics (T <sub>A</sub> = 25°C unless otherwise noted)									
Symbol	Parameter	Conditions	Min	Тур	Max	Units			
OFF CHA	RACTERISTICS								
I <sub>FL</sub>	Forward Leakage Current	$V_{IN} = 8 V, V_{ONOFF} = 0 V$			1	μA			
ON CHAR	ACTERISTICS (Note 3)								
V <sub>drop</sub>	Conduction Voltage Drop	$V_{IN} = 5 \text{ V}, V_{ON/OFF} = 3.3 \text{ V}, I_{L} = 1.5 \text{ A}$		0.15	0.2	V			
		$V_{IN} = 3.3 \text{ V}, V_{ONOFF} = 3.3 \text{ V}, I_{L} = 1.2 \text{ A}$		0.145	0.2				
		$V_{IN} = 2.5 \text{ V}, V_{ONOFF} = 3.3 \text{ V}, I_{L} = 1 \text{ A}$		0.13	0.2				
R <sub>(ON)</sub>	Q <sub>2</sub> - Static On-Resistance	$V_{GS} = -5 V, I_{D} = -1.8 A$		0.115	0.13	Ω			
		$V_{GS} = -3.3 \text{ V}, I_{D} = -1.6 \text{ A}$		0.13	0.16				
		$V_{GS} = -2.5 \text{ V}, I_{D} = -1.5 \text{ A}$		0.155	0.18				
I <sub>L</sub>	Load Current	$V_{DROP} = 0.13 \text{ V}, V_{IN} = 5 \text{ V}, V_{ONOFF} = 3.3 \text{ V}$	1			Α			
		$V_{\text{DROP}} = 0.16 \text{ V}, V_{\text{IN}} = 3.3 \text{ V}, V_{\text{ON/OFF}} = 3.3 \text{ V}$	1			1			
		$V_{DROP} = 0.2 \text{ V}, V_{IN} = 2.5 \text{V}, V_{ONOFF} = 3.3 \text{ V}$	1			1			

Notes:

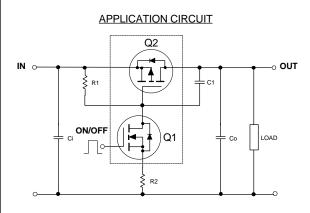
1. V<sub>IN</sub>=8V, V<sub>ONOFF</sub>=8V, T<sub>A</sub>=25°C

2. R<sub>6,14</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface

of the drain pins.  $R_{_{\theta^{JC}}}$  is guaranteed by design while  $R_{_{\theta^{CA}}}$  is determined by the user's board design.

3. Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2.0%.

# FDC6325L Load Switch Application

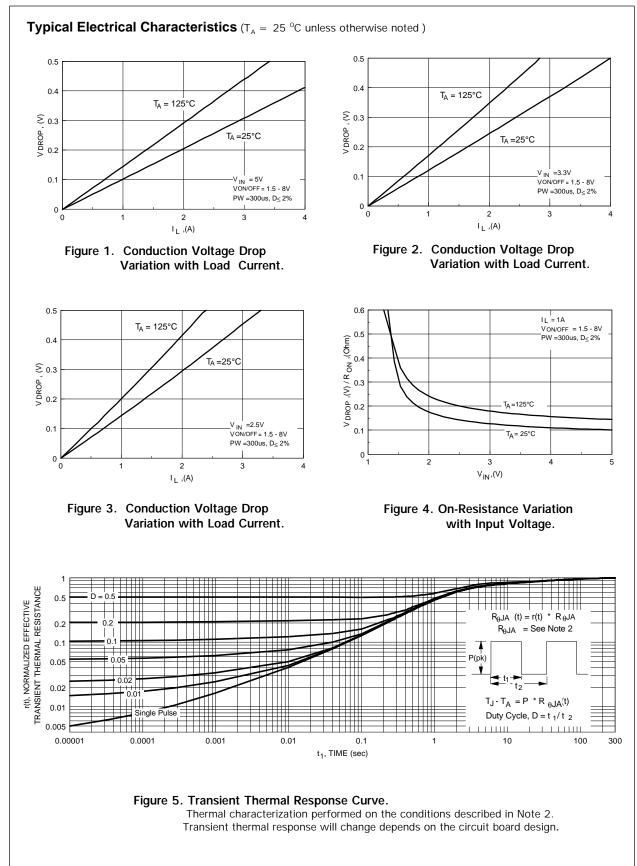


## **External Component Recommendation**

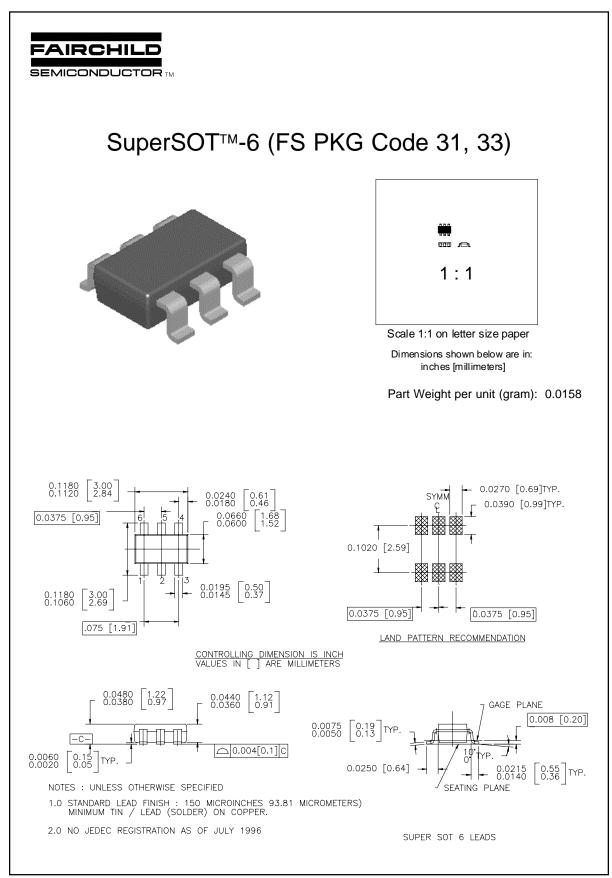
For Coff 1uF applications:

First select R2, 100 - 1kW, for Slew Rate control. C1  $\pm$  1000pF can be added in addition to R2 for further In-rush current control.

Then select R1 such that R1/R2 ratio maintains between 10 - 100. R1 is required to turn Q2 off. For SPICE simulation, users can download a "FDC6325L.MOD" Spice model from Fairchild Web Site at www.fairchildsemi.com



## FDC6325L Rev.D1



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